

## PATENT ASSIGNMENT COVER SHEET

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TAKASHI OHSHIMA	08/26/2014
HIROYUKI MORIMOTO	08/26/2014
YUHEI SHIMIZU	08/30/2014
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14382455
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<b>SIGNATURE:</b>	/Jay F. Moldovanyi/
<b>DATE SIGNED:</b>	09/02/2014
<b>Total Attachments: 1</b>	
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**ASSIGNMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged, I/We, the undersigned,

**Takashi Ohshima, Hiroyuki Morimoto, Yuhei Shimizu**

who has/have created a certain invention for which an application for United States Letters Patent has been

- ☐ executed concurrently herewith
- ☐ executed on \_\_\_\_\_
- ☐ filed as U.S. Serial No. \_\_\_\_\_ on \_\_\_\_\_
- ☒ filed as International Application No. PCT/JP2013/055845 on 4 March 2013

and is entitled **PRODUCTION METHOD FOR COMPOUND COMPRISING AMINO GROUP AND/OR HYDROXYL GROUP**

Do hereby sell, assign and transfer to **Kyushu University, National University Corporation**, a corporation of Japan, having a place of business at 6-10-1, Hakozaki, Higashi-ku, Fukuoka-shi, Fukuoka 8128581 Japan, its successors, assigns, and legal representatives, the full and exclusive right, title, and interest in and to said invention and said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, reexaminations, extensions thereof, and all other forms of protection relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions agreements, acts, and treaties;

Agree that **Kyushu University, National University Corporation**, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reexaminations, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Assignee to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

IN TESTIMONY WHEREOF I/WE have hereunto set MY/OUR signature(s) on the date(s) indicated below.

Takashi Ohshima  
Name: Takashi Ohshima

Hiroyuki Morimoto  
Name: Hiroyuki Morimoto

Date 08/26/2014

Date 08/26/2014

Yuhei Shimizu  
Name: Yuhei Shimizu

Date 08/30/2014

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